


APPLICATION DATA SHEET

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| Title of Invention | [METHOD OF FABRICATING THIN FILM TRANSISTOR ARRAY SUBSTRATE AND STACKED THIN FILM STRUCTURE] | | |
| Application Type : regular, utility Attorney Docket Number : 12406-US-PA | | | |
| Correspondence address: Customer Number: 31561  | | | |
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| Inventor Information: <u>Inventor 1:</u> Applicant Authority Type: Inventor Citizenship: TW Name prefix: Mr. Given Name: Han-Chung Family Name: Lai Residence: City of Residence: Taoyuan Hsien Country of Residence: TW Address-1 of Mailing Address: No. 20, Alley 63, Lane 122, Chengkung Rd., Address-2 of Mailing Address: Chungli, City of Mailing Address: Taoyuan Hsien State of Mailing Address: Postal Code of Mailing Address: Country of Mailing Address: TW Phone: Fax: E-mail: | | | |
| Attorney Information: practitioner(s) at Customer Number: | | | |

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